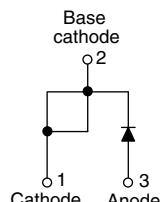
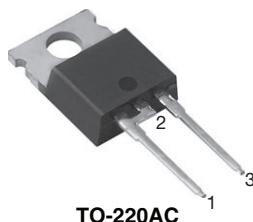


## Ultralow $V_F$ Hyperfast Rectifier for Discontinuous Mode PFC, 15 A FRED Pt®


**VS-15ETL06HN3**

### FEATURES

- Hyperfast recovery time
- Benchmark ultralow forward voltage drop
- 175 °C operating junction temperature
- Low leakage current
- AEC-Q101 qualified
- Meets JESD 201 class 2 whisker test
- Material categorization:  
for definitions of compliance please see  
[www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT  
HALOGEN  
FREE

### DESCRIPTION

State of the art, ultralow  $V_F$ , soft-switching hyperfast rectifiers optimized for Discontinuous (Critical) Mode (DCM) Power Factor Correction (PFC).

The minimized conduction loss, optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

The device is also intended for use as a freewheeling diode in power supplies and other power switching applications.

### APPLICATIONS

AC/DC SMPS 70 W to 400 W

e.g. laptop and printer AC adaptors, desktop PC, TV and monitor, games units and DVD AC/DC power supplies.

PRODUCT SUMMARY	
Package	TO-220AC
$I_{F(AV)}$	15 A
$V_R$	600 V
$V_F$ at $I_F$	0.85 V
$t_{rr}$ typ.	60 ns
$T_J$ max.	175 °C
Diode variation	Single die

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Peak repetitive reverse voltage	$V_{RRM}$		600	V
Average rectified forward current	$I_{F(AV)}$	$T_C = 153$ °C	15	A
Non-repetitive peak surge current	$I_{FSM}$	$T_J = 25$ °C	250	
Peak repetitive forward current	$I_{FM}$		30	
Operating junction and storage temperatures	$T_J, T_{Stg}$		-65 to +175	°C

ELECTRICAL SPECIFICATIONS ( $T_J = 25$ °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	$V_{BR}, V_R$	$I_R = 100$ µA	600	-	-	V
Forward voltage	$V_F$	$I_F = 15$ A		-	0.99	1.05
		$I_F = 15$ A, $T_J = 150$ °C	-	0.85	0.92	
Reverse leakage current	$I_R$	$V_R = V_R$ rated	-	0.1	10	µA
		$T_J = 150$ °C, $V_R = V_R$ rated	-	15	120	
Junction capacitance	$C_T$	$V_R = 600$ V	-	20	-	pF
Series inductance	$L_S$	Measured lead to lead 5 mm from package body	-	8.0	-	nH

DYNAMIC RECOVERY CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Reverse recovery time	$t_{rr}$	$I_F = 1 \text{ A}$ , $dI_F/dt = 100 \text{ A}/\mu\text{s}$ , $V_R = 30 \text{ V}$		-	60	-	ns
		$I_F = 15 \text{ A}$ , $dI_F/dt = 100 \text{ A}/\mu\text{s}$ , $V_R = 30 \text{ V}$		-	190	-	
		$T_J = 25^\circ\text{C}$	$I_F = 15 \text{ A}$ $dI_F/dt = 200 \text{ A}/\mu\text{s}$ $V_R = 390 \text{ V}$	-	220	-	
		$T_J = 125^\circ\text{C}$		-	320	-	
Peak recovery current	$I_{RRM}$	$T_J = 25^\circ\text{C}$		-	19	-	A
		$T_J = 125^\circ\text{C}$		-	26	-	
Reverse recovery charge	$Q_{rr}$	$T_J = 25^\circ\text{C}$		-	2.2	-	$\mu\text{C}$
		$T_J = 125^\circ\text{C}$		-	4.3	-	

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	$T_J, T_{Stg}$			-65	-	175	$^\circ\text{C}$
Thermal resistance, junction to case	$R_{thJC}$			-	1.1	1.4	$^\circ\text{C}/\text{W}$
Thermal resistance, junction to ambient per leg	$R_{thJA}$	Typical socket mount		-	-	70	
Thermal resistance, case to heatsink	$R_{thCS}$	Mounting surface, flat, smooth, and greased		-	0.5	-	
Weight				-	2.0	-	g
				-	0.07	-	oz.
Mounting torque				6.0 (5.0)	-	12 (10)	$\text{kgf} \cdot \text{cm}$ ( $\text{lbf} \cdot \text{in}$ )
Marking device		Case style TO-220AC		15ETL06H			

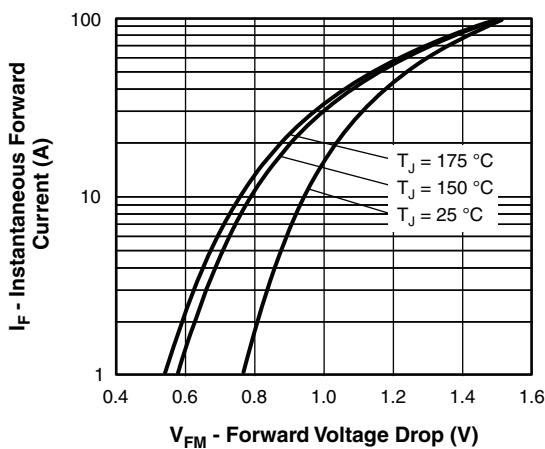


Fig. 1 - Maximum Forward Voltage Drop Characteristics

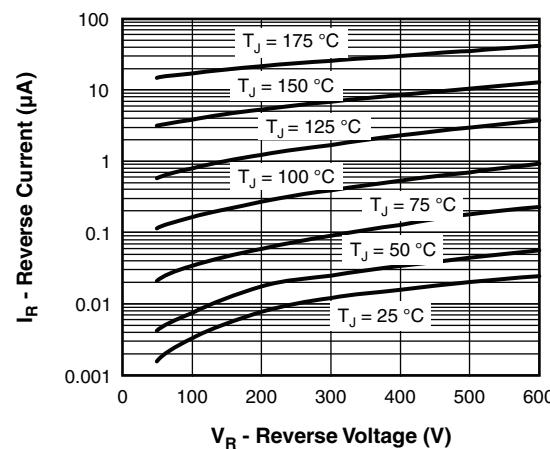


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

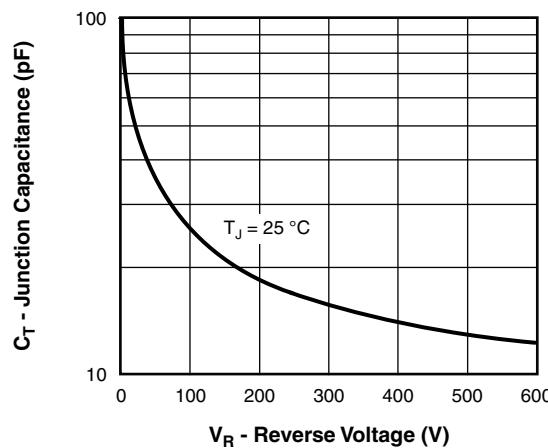


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

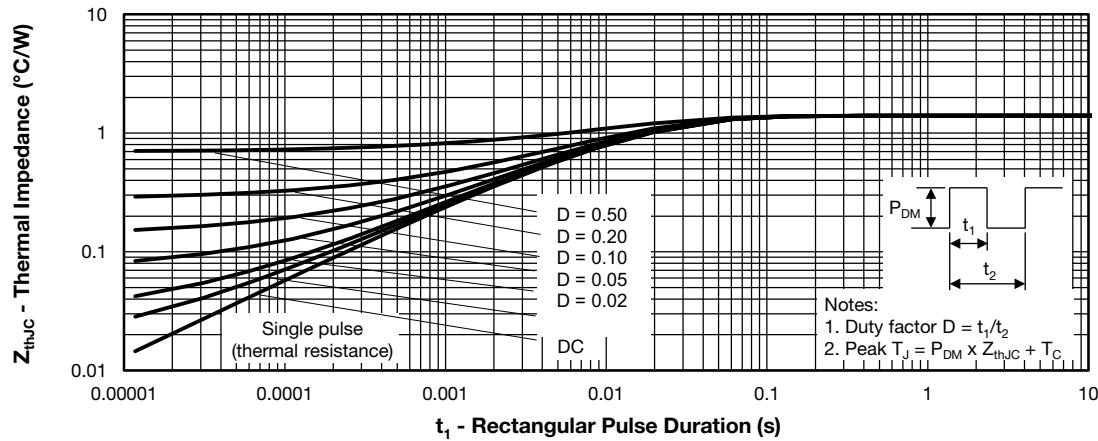


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics

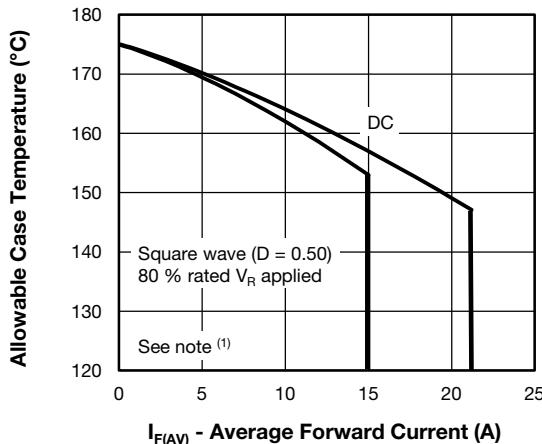


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

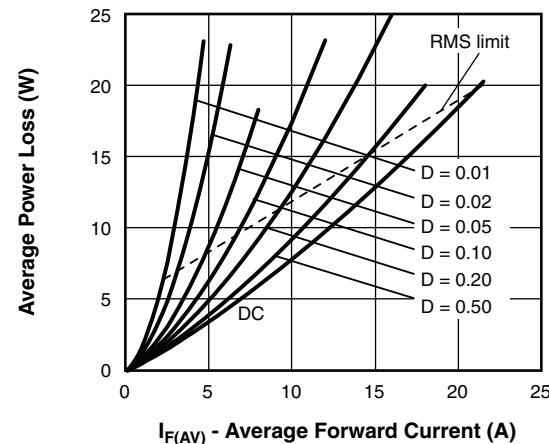


Fig. 6 - Forward Power Loss Characteristics

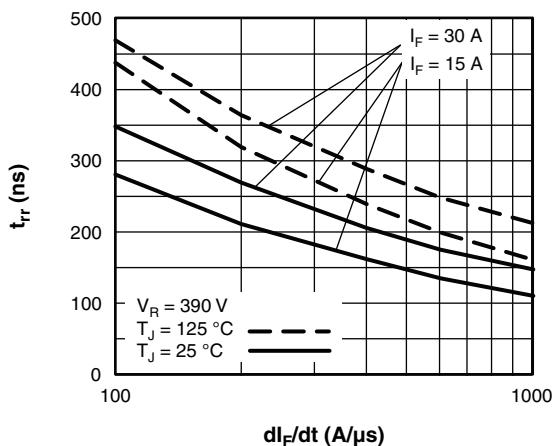


Fig. 7 - Typical Reverse Recovery Time vs.  $dI_F/dt$

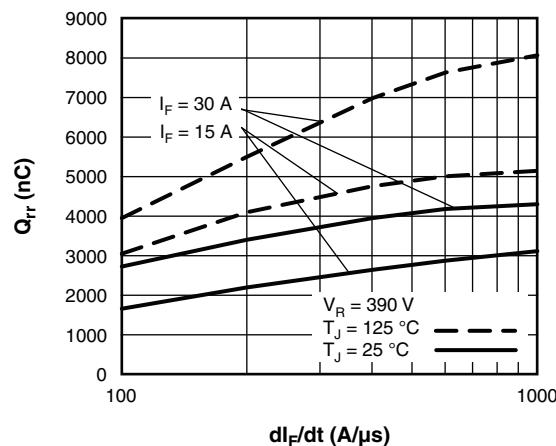
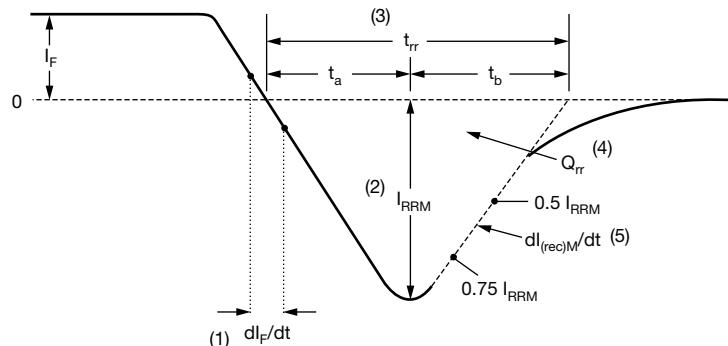


Fig. 8 - Typical Stored Charge vs.  $dI_F/dt$



(1)  $dI_F/dt$  - rate of change of current through zero crossing

(4)  $Q_{rr}$  - area under curve defined by  $t_{rr}$  and  $I_{RRM}$

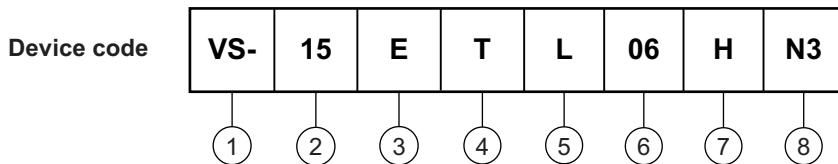
(2)  $I_{RRM}$  - peak reverse recovery current

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(3)  $t_{rr}$  - reverse recovery time measured from zero crossing point of negative going  $I_F$  to point where a line passing through 0.75  $I_{RRM}$  and 0.50  $I_{RRM}$  extrapolated to zero current.

(5)  $dI_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$

Fig. 9 - Reverse Recovery Waveform and Definitions

**ORDERING INFORMATION TABLE**


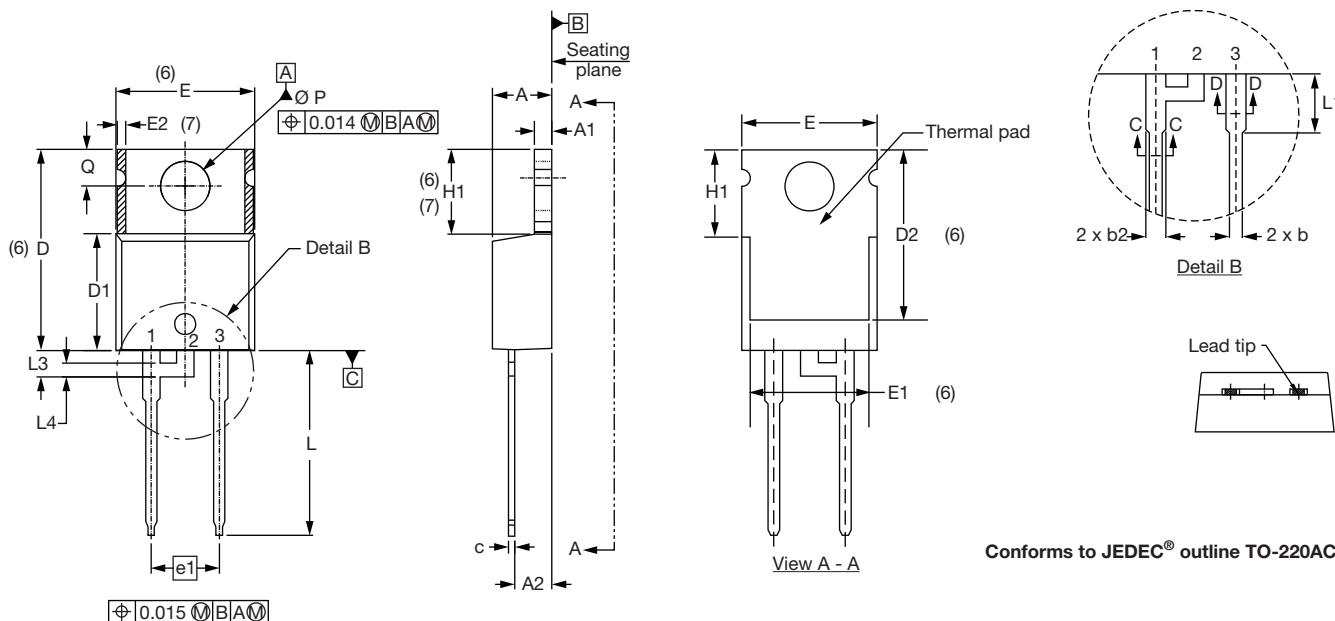
- 1** - Vishay Semiconductors product
- 2** - Current rating (15 = 15 A)
- 3** - E = single diode
- 4** - T = TO-220
- 5** - L = ultralow  $V_F$  hyperfast recovery
- 6** - Voltage rating (06 = 600 V)
- 7** - H = AEC-Q101 qualified
- 8** - Environmental digit:  
N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

<b>ORDERING INFORMATION</b> (Example)			
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-15ETL06HN3	50	1000	Antistatic plastic tube

<b>LINKS TO RELATED DOCUMENTS</b>	
Dimensions	<a href="http://www.vishay.com/doc?95221">www.vishay.com/doc?95221</a>
Part marking information	<a href="http://www.vishay.com/doc?95068">www.vishay.com/doc?95068</a>
SPICE model	<a href="http://www.vishay.com/doc?96051">www.vishay.com/doc?96051</a>

### TO-220AC

**DIMENSIONS** in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
c	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6
E	10.11	10.51	0.398	0.414	3, 6

#### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimension: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimension E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, D2 (minimum) where dimensions are derived from the actual package outline

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